

Email: sales@engineeringlabequipments.com

Product Name:
Tin Lead Plating Machine

Product Code:
ENGLABINGCAG5200014



Description:

Tin Lead Plating Machine

Technical Specification:

Double sides, multi layer circuit board etc. non-metal material double side drilling hole protection.

Full ABS engineer plastic machine and inner groove, antiseptic, anti high temperature, anti vibration, technology flow is good, outlook is beautiful.

Cathode oscillation technology, prevent concentration gradient, add hole liquid flow. Swing time:3-5 times/minute.

Technical specification:

Max panel:400x400mm, it can electroplate for 5 boards at the same time.

Minimum hole:0.6mm

Max thickness diameter ratio, 3:1

Output voltage:0-15V,adjustable continuously

Output current:0-20A, adjustable continuously

With 2 groove, one is for tin-lead plating, the other is for quit tin-lead.

Engineering Lab Equipment India

